Service Manual

Integrated Telephone System

Data Port ::::

Telephone Equipment

KX-TS15-W

White Version

(for U.S.A)



SPECIFICATIONS

Power Source:

Telephone line voltage

Memory Capacity:

26 telephone numbers, up to 21 digits for

each station

Dial Speed:

Tone (DTMF) /Pulse (10 pps)

Redial:

Last dialed telephone number

Pause:

3.5 sec

Speaker:

Handset; 3 cm (13/16) PM dynamic type

receiver unit, $150\,\Omega$

Microphone: Dimensions:

Electret condenser microphone

 $8^{3}/_{4}$ " $\times 6^{23}/_{32}$ " $\times 3^{1}/_{2}$ " (222 \times 171 \times 89 mm)

Weight:

1.37 lbs. (620g)

Design and specifications are subject to change without notice.

Panasonic

№ WARNING

This service information is designed for experienced repair technicians only and is not designed for use by the general public. It does not contain warnings or cautions to advise non-technical individuals of potential dangers in attempting to service a product. Products powered by electricity should be serviced or repaired only by experienced professional technicians.

Any attempt to service or repair the product or products doubt with in this caprice information by experienced professional technicians.

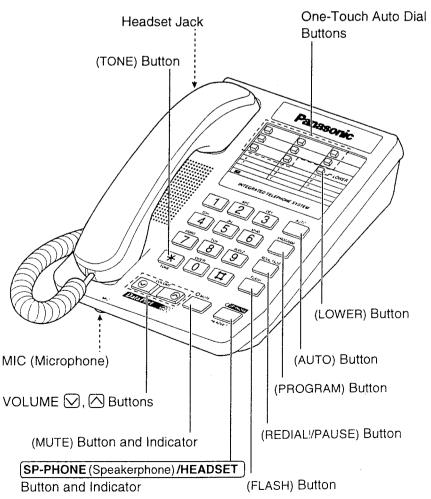
Any attempt to service or repair the product or products dealt with in this service information by anyone else could result in serious injury or death.

When you mention the serial number, write down all 11 digits. The serial number may be found on the label affixed to the bottom of the unit.

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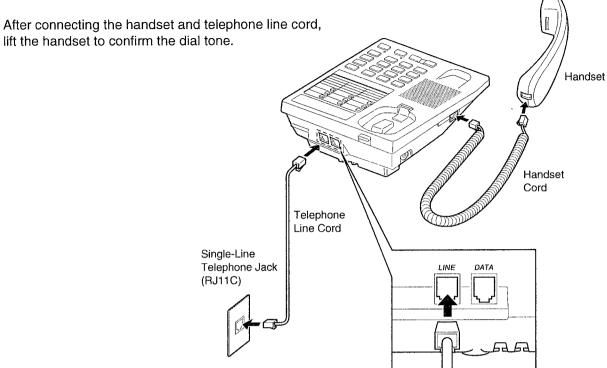
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LOCATION OF CONTROLS



CONNECTION

Connecting the Handset/Telephone Line Cord

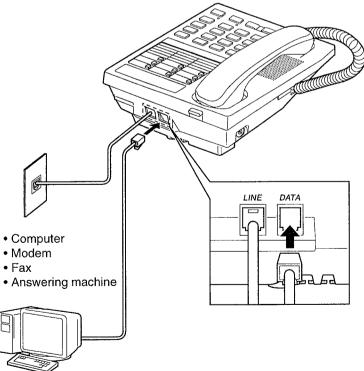


• Use only a Panasonic Handset for the KX-TS15-W.

Connecting a Communication Device

If you connect a communication device (computer, modem, fax, answering machine, etc.) to the telephoen line, you can connect it through this unit using the DATA jack (—Data Port).

After connecting the handset and telephone line cord, connect the communication device telephone line cord to the DATA jack.



• Be sure that the communication device is not in use before using this unit (making calls, storing phone numbers in memory, etc.), or the communication device may not operate properly.

OPERATION

Selecting the Dialing Mode

You can select the dialing mode by programming. If you have touch tone service, set to TONE. If rotary or pulse service is used, set to PULSE. Your phone comes from the factory set to TONE.

1 Lift the handset.

Press PROGRAM

• The MUTE indicator flashes.

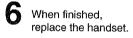
Press 3

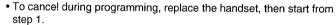
To select PULSE, press 0. OR

To select TONE, press 1.

Press PROGRAM.

 A beep sounds on the handset and the MUTE indicator light goes out.





If 4 beeps sound during programming, a wrong key was pressed.
 Replace the handset, then start from step 1.

Making Calls

You can make a call by simply lifting the handset. To hang up, place the handset on the cradle.

Using the speakerphone

Press SP-PHONE/HEADSET

The indicator lights.

Dial a phone number.If you misdial, hang up and start from step 1.

When the other party answers, talk into the MIC (microphone).

To hang up, press

SP-PHONE/HEADSET

• The indicator light goes out.

VOLUME

MIC

REDIAL/PAUSE

SP-PHONE/HEADSET

and Indicator

During the speakerphone operation:

 For best speakerphone performance, talk alternately with the caller in a quiet room.

If the caller complains that your voice is hard to hear, press VOL-

UME to decrease the speaker volume.

 You can switch to the handset by lifting it up. To switch back to the speakerphone, press [SP-PHONE/HEADSET].

To adjust the handset volume (5 levels) or the speaker volume (9 levels) while talking

To increase, press VOLUME

To decrease, press **VOLUME** .

 After hanging up, the handset volume will return to the middle level.

To redial the last number dialed

Lift the handset or press SP-PHONE/HEADSET → press REDIAL/PAUSE.

Answering Calls

While a call is being received, the unit rings. You can answer it by simply lifting the handset.

Using the speakerphone

Press SP-PHONE/HEADSET

The indicator lights.

Talk into the MIC (microphone).

To hang up, press

SP-PHONE/HEADSET).

• The indicator light goes out.

When the ringer volume is set to OFF, the unit will not ring.

When the optional headset is connected to the unit, be sure to use the headset to talk with the caller. If you want to have a normal phone conversation, disconnect the headset before making or answering a call.

(SP-PHONE/HEADSET)

MIC

Speed Dialer

Storing Phone Numbers in Memory

You can store up to 10 phone numbers in the memory stations. The dialing buttons ([0] to [9]) function as memory station numbers. Do not press any memory stations before storing to prevent misoperation.

Lift the handset.

Press PROGRAM

• The MUTE indicator flashes.

Memory Station Numbers Press AUTO. Press a memory station number (0 to 9). Enter a phone number up to 21

Press PROGRAM · A beep sounds on the handset and the MUTE indicator ligh goes out.

When finished, replace the handset. To store other numbers, repeat steps 1 through 7.

• If a pause is required for dialing, [REDIAL/PAUSE] can be stored in a phone number counting as one digit.

• To cancel during programming, replace the handset, then start from step 1.

• If 4 beeps sound during programming, a wrong key was pressed. Replace the handset, then start from step 1.

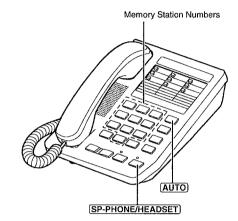
Dialing a Stored Number

Lift the handset or press SP-PHONE/HEADSET.

Press AUTO.

Press the memory station number (0 to 9).

• The stored number is displayed.



Dialing a Stored Number

With an UPPER memory location:

Lift the handset or press SP-PHONE/HEADSET.

Press the desired one-touch auto dial button.

• The stored number is dialed.

OR

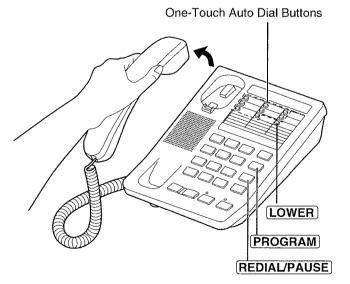
With a LOWER memory location:

Lift the handset or press SP-PHONE/HEADSET.

Press LOWER.

Press the desired one-touch auto dial button.

· The stored number is dialed.



(PROGRAM)

REDIAL/PAUSE

MUTE Indicator

One-Touch Dialer

You can store up to 16 phone numbers in the one-touch auto dial buttons (8 numbers in UPPER memory locations, 8 numbers in LOWER memory locations).

Storing Phone Numbers in Memory

Do not press any one-touch auto dial buttons before storing to prevent misoperation.

To store in an UPPER memory location

Lift the handset.

Press PROGRAM.

• The MUTE indicator flashes.

Press one of the one-touch auto

dial buttons.

Enter a phone number up to 21 digits.

Press PROGRAM.

 A beep sounds on the handset and the MUTE indicator light goes out.

the handset.
• To store other numbers, repeat steps 1 through 6.

When finished, replace



To store in a LOWER memory location

Lift the handset.

Press PROGRAM.

• The MUTE indicator flashes.

Press LOWER to select a lower memory location.

Press one of the one-touch auto dial buttons.

5 Enter a phone number up to 21 digits.

Press PROGRAM.
 A beep sounds on the handset and the MUTE indicator light goes out.

When finished, replace the handset.

 To store other numbers, repeat steps 1 through 7. One-Touch Auto Dial Buttons

LOWER

PROGRAM

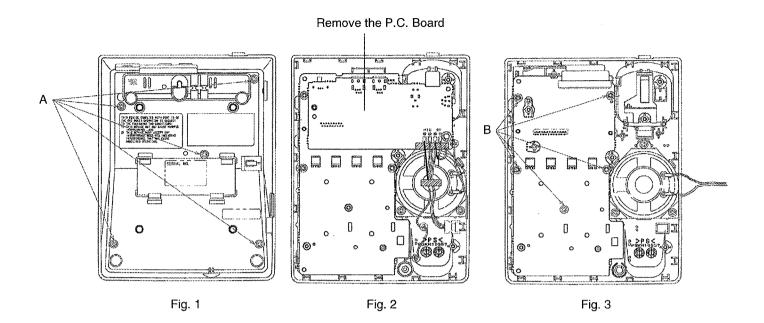
MUTE Indicator REDIAL/PAUSE

 If a pause is required for dialing, REDIAL/PAUSE can be stored in a phone number counting as one digit.

• To cancel during programming, replace the handset, then start from sten 1

If 4 beeps sound during programming, a wrong key was pressed.
 Replace the handset, then start from step 1.

DISASSEMBLY INSTRUCTIONS



Ref. No.	Procedure	Shown in Fig.—	To remove—.	Remove—.
1	1	1 .	Cabinet Cover	Screws (3u12) (A)u5
2	1, 2	2	Main Printed Circuit Board	Remove the P.C. Board
3	1~3	3	Operation Printed Circuit Board	Screws (3u10) (B)u5

HOW TO REPLACE FLAT PACKAGE IC

PREPARATION

· SOLDER _ _ _ _ Sparkle Solder 115A-1, 115B-1

OR

Almit Solder KR-19, KR-19RMA

· Soldering iron - - - - Recommended power consumption will be between 30 W to 40 W.

Temperature of Copper Rod 662 \pm 50 °F (350 \pm 10 °C)

(An expert may handle 60~80 W iron, but beginner might

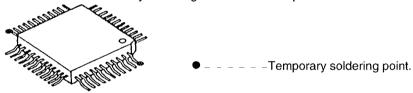
damage foil by overheating.)

· Flux - - - - - - HI115 Specific gravity 0.863

(Original flux will be replaced daily.)

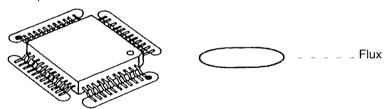
PROCEDURE

1. Temporary fix FLAT PACKAGE IC by soldering on two marked 2 pins.

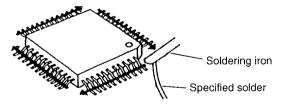


*Most important matter is accurate setting of IC to the corresponding soldering foil.

2. Apply flux for all pins of FLAT PACKAGE IC.

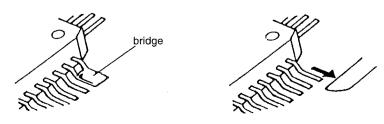


3. Solder employing specified solder to direction of arrow, as sliding the soldering iron.

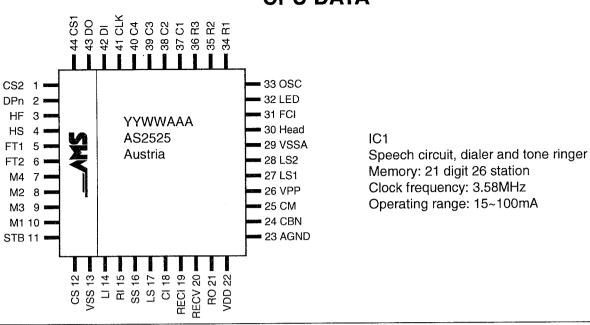


MODIFICATION PROCEDURE OF BRIDGE

- 1. Re-solder slightly on bridged portion.
- 2. Remove remained solder along pins employing soldering iron as shown in below figure.



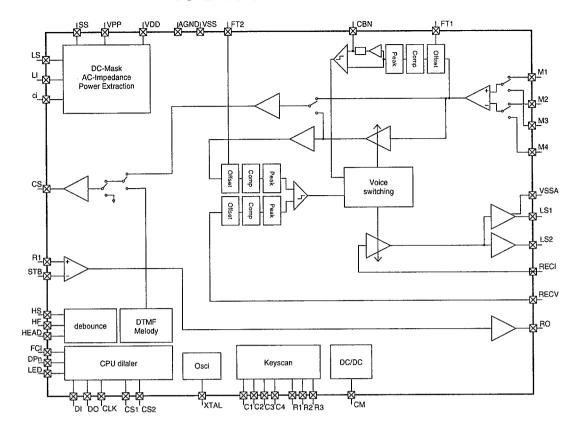
CPU DATA



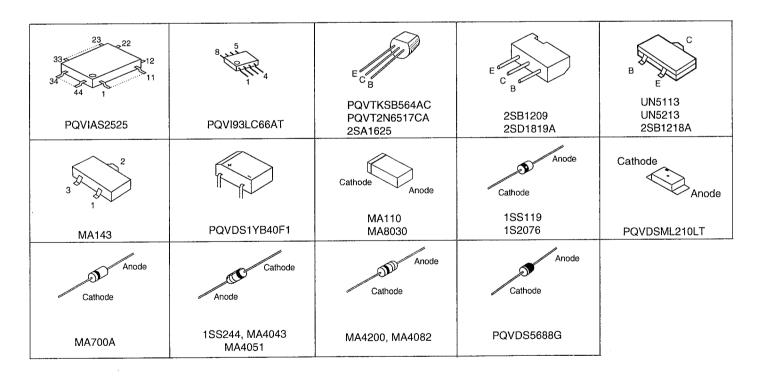
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Pin No.	Symbol	Function		
1	CS2	ChipSelect 2 Chip select signal for external LCD driver circuit or 2mA LED. If signal is not activated a pull down resistor (100kOhm) is inserted.		
2	DPn	Dial Pulse Output Digital output which holds the line during off-hook operation or pulls low during break periods of pulse dialing and flash.		
3	HF	HandsFree Switch Input This is an Schmitt-trigger input that is pulled high indicating handsfree operation.		
4	HS	HandSet Switch Input This is an Schmitt-trigger input that is pulled high by the hook switch indicating handset or headset operation.		
5	FT1	Analog input pin for connecting a capacitor for offset cancellation.		
6	FT2	Analog input pin for connecting a capacitor for offset cancellation.		
7	M4	Microphone Input 4 Differential input for the handsfree microphone (electret).		
8	M2	Microphone Input 2 Differential input for the handset microphone (electret).		
9	M3	Microphone Input 3 Differential input for the handsfree microphone (electret).		
10	M1	Microphone Input 1 Differential input for the handset microphone (electret).		
11	STB	Side Tone Balance Input Analog input for side tone cancellation network.		
12	CS	Current Shunt Control Output N-channel open drain output to control the external high power shunt transistor for synthesising AC- and DC-impedance, modulation of line voltage and shorting the line during make periods of pulse dialing.		
13	VSS	Voltage Source Negative Power Supply		
14	LI	Line Input Analog input used for power extraction and line current sensing.		
15	RI	Receive Input Analog input for ac-separated receive signal.		
i				

Pin No.	Symbol	Function
16	SS	Supply Source Control Output N-channel open drain output to control the external high power source transistor for supplying (Vpp) the loudspeaker amplifier in off-hook loudspeaking/handsfree mode.
17	LS	Line Current Sense Input Analog input for sensing the line current.
18	CI	Complex Impedance Input Analog input pin for the capacitor to program a complex impedance.
19	RECI	Analog input for the handsfree receive path. Schould be connected to RO via coupling capacitor.
20	RECV	Analog input for receive voice switching path.
21	RO	Receive Output to Handset Output for driving a dynamic earpiece with an impedance from 150 Ω to 300 Ω .
22	VDD	Voltage Drain Drain Positive Power Supply
23	AGND	Analog Ground Special ground for the internal amplifiers.
24	CBN	Analog Input pin for connecting a capacitor for background noise monitoring.
25	СМ	Converter Make Output This is an output for controling the external switching converter. During ringing it converts the ring signal into a 4V supply voltage.
26	VPP	Loudspeaker Power Supply High power supply for the output driver stage.
27 28	LS1 LS2	Loudspeaker Output 1 Output pins for a 32Ω (25 to 50Ω) loudspeaker
29	VSSA	Power supply pin for LS1-LS2 output amplifier.
30	HEAD	HEADset Switch Input Digital input for choosing handset and headset mode or choosing between LD and MF dialing. See section "Service Code Programming 4" for further details. This pin is scanned only after manual OFF-HOOK.
31	FCI	Frequency Comparator Input This is a Schmitt-trigger input for ring frequency discrimination. Disabled during off-hook.
32	LED	LED Output Digital output for connecting 2mA LED.
33	OSC	Oscillator Input Input for ceramic resonator 3.58MHz.
34 35 36	R1 R2 R3	Keyboard Rows (see key arrangement)
37 38 39 40	C1 C2 C3 C4	Keyboard Columns (see key arrangement)
41	CLK	Clock Clock output of 3 wire bus. If signal is not activated a pull down resistor (100kOhm) is inserted.
42	DI	DataInput Data input of 3 wire bus. If signal is not activated a pull down resistor (100kOhm) is inserted.
43	DO	DataOutput Data output of 3 wire bus. A 100k resistor connected from this pin to vss enables key-locking. If signal is not activated a pull down resistor (100kOhm) is inserted.
44	CS1	ChipSelect 1 Chip select signal for external EEPROM. If signal is not activated a pull down resistor (100kOhm) is inserted.

IC BLOCK DIAGRAM



TERMINAL GUIDE OF IC'S TRANSISTORS ANS DIODES



SERVICE CORD PROGRAMMING

item	(remark)	procedure
interdigit pause	(840ms)	PROG→0→0123→*1→E17→PROG
tone duration	(82ms)	PROG→0→0123→*2→FD0→PROG
inter tone pause	(82ms)	PROG→0→0123→*3→FD2→PROG
flash time 1	(700ms)	PROG→0→0123→*4→FC8→PROG
flash time 2	(100ms)	PROG→0→0123→*5→E64→PROG
pause time 1	(3500ms)	PROG→0→0123→*6→809→PROG
pause time 2	(3500ms)	PROG→0→0123→*7→809→PROG
Handset TX gain	(37dB)	PROG→0→0123→01→7→PROG
Handset RX gain	(1dB)	PROG→0→0123→02→7→PROG
Handsfree TX gain	(49dB)	PROG→0→0123→03→A→PROG
handsfree RX gain	(37dB)	PROG→0→0123→04→F→PROG
LLC	(off)	PROG→0→0123→05→0→PROG
DTMF Level	(-6dBm)	PROG→0→0123→06→C→PROG
Headset TX gain	(44dB)	PROG→0→0123→07→E→PROG
Headset RX gain	(1dB)	PROG→0→0123→08→7→PROG
Handset DTMF comf.	(-30dBr)	PROG→0→0123→09→1→PROG
Handsfree DTMF comf.	(-9dBr)	PROG→0→0123→00→1→PROG
Make/Break time	(40/60ms)	PROG→0→0123→#1→1→PROG
Pulse per socond	(10pps)	PROG→0→0123→#2→0→PROG
LI Voltage	(4.5V)	PROG→0→0123→#3→1→PROG
Handset TX softclip	(on)	PROG→0→0123→#4→1→PROG
Handset RX softclip	(off)	PROG→0→0123→#5→0→PROG
Background Noise Monitor	(off)	PROG→0→0123→#6→0→PROG
Melody 2/3 tone	(3 tone)	PROG→0→0123→#8→1→PROG
Key Beep	(on)	PROG→0→0123→#9→1→PROG
PIN code reset		PROG→0→0123→#0→1→PROG
Flash 1 during LD	(on)	PROG→0→0123→#*→1→PROG
Flash 2 during LD	(on)	PROG→0→0123→##→1→PROG
Extended symbols	(off)	PROG→0→0123→91→0→PROG
Handsfree TX softclip	(on)	PROG→0→0123→92→1→PROG
Handsfree RX softclip	(off)	PROG→0→0123→93→0→PROG
Voice switch speed	(speed 4)	PROG→0→0123→94→2→PROG
Hook resets RX volume	(on)	PROG→0→0123→95→1→PROG
*is temp MF and *	(off)	PROG→0→0123→97→0→PROG
Key lock enable	(on)	PROG→0→0123→98→1→PROG
Head pin	(Headset)	PROG→0→0123→99→0→PROG
Ring OFF selectable	(on)	PROG→0→0123→90→1→PROG
Handset VOL control	(on)	PROG→0→0123→9#→1→PROG

ex.) Input the interdigit pause (840ms).

$$\begin{array}{c} \hline \text{PROGRAM} \rightarrow 0 \rightarrow 0 \rightarrow 1 \rightarrow 2 \rightarrow 3 \rightarrow \text{\times} \rightarrow 1 \rightarrow \text{E} \rightarrow 1 \rightarrow 7 \rightarrow \text{PROGRAM} \end{array}$$

Calculating Data word.

DATA =
$$4096 - \left(\frac{3580000}{512 \times 12} \times T\right)$$
 T: Duration (sec) DATA: 12bit result

	A B C	D E F	
The key arrangement for above program is as shown in the drawing. →	1 4 7 ×	2 3 5 6 8 9 0 #	PROG

FOR SCHEMATIC DIAGRAM (page 17)

Notes:

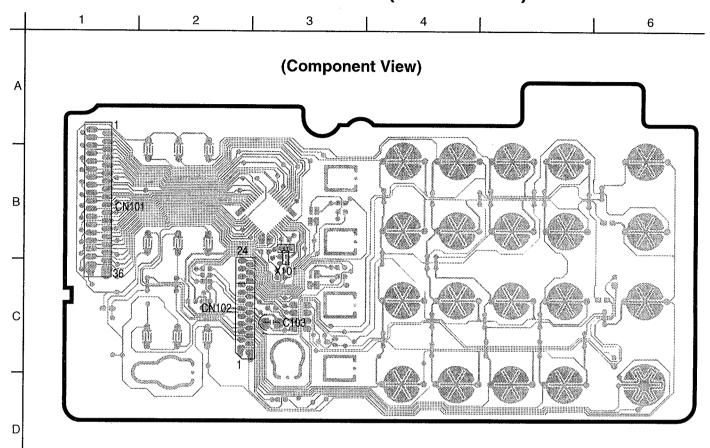
- 1. S1: Hook switch in "OFF-HOOK" position.
- 2. S2: Dialing mode selector switch in "TONE" position.
- 3. S3: Ringer volume selector switch in "HIGH" position.
- DC voltage measurements are taken with electronic voltmeter from negative terminal of battery.
 (Add 40 mA to telephone line from the loop simulator.)
- 5. This schematic diagram may be modified at any time with the development of new technology.

6. Important Safety Notice:

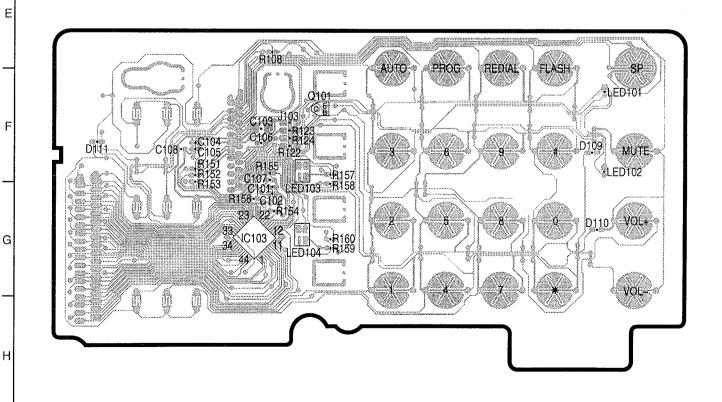
The shaded area on this schematic diagram incorporates special features important for protection from fire and electrical shock hazards.

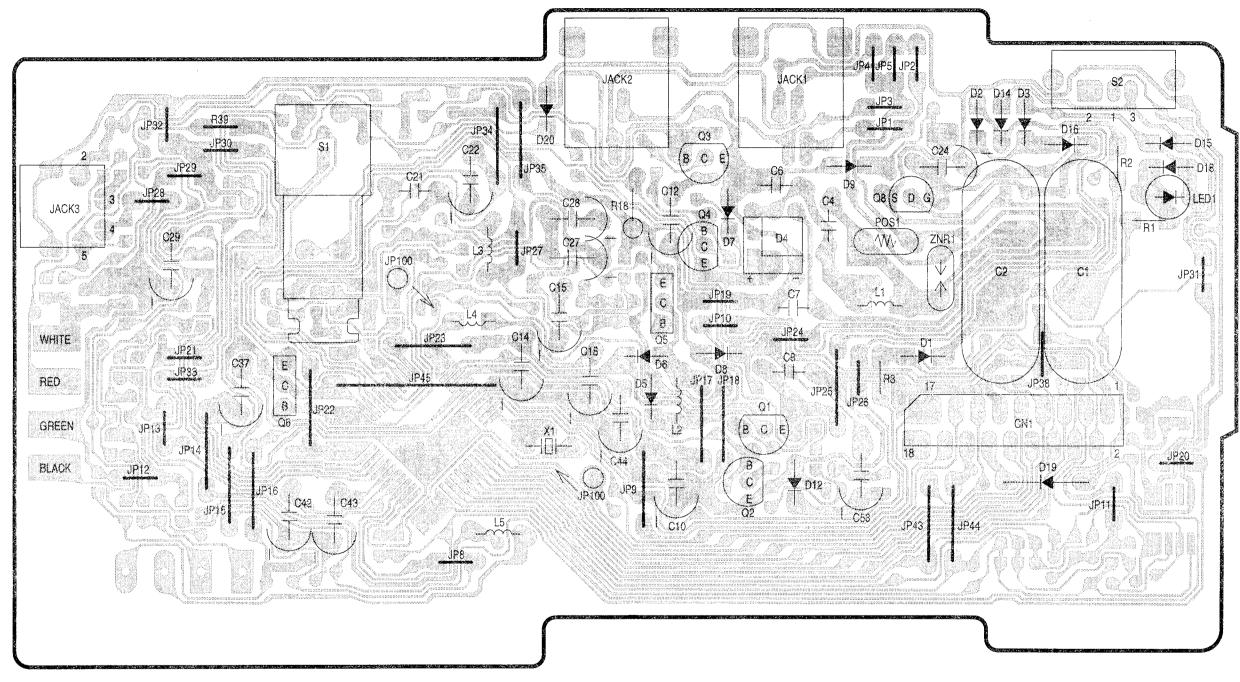
When servicing it is essential that only manufacturer's specified parts be used for the critical components in the shaded areas of the schematic.

CIRCUIT BOARD (OPERATION)



(Flow Solder Side View)





Notes:

This board may be modified at any time with the development of new technology.

KX-TS15-W KX-TS15-W

CIRCUIT BOARD AND WIRING CONNECTION DIAGRAM

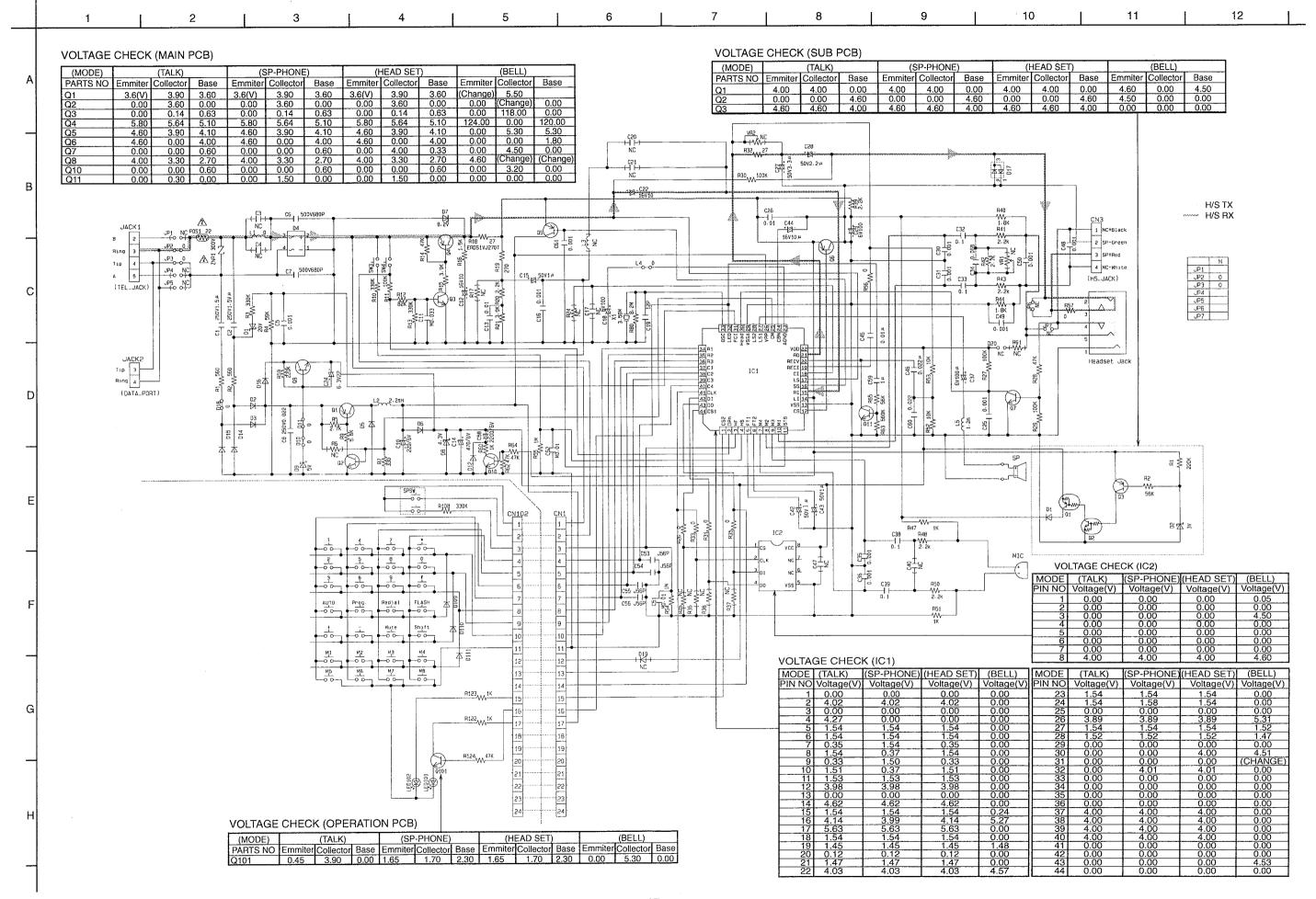
10 11 12 (Flow Solder Side View) Rio **C11 R1**3 R40 D17 R41 R57 JP6 A15 C31 C33 JP7 R42 C34 C61 R19 A17 A21 C13 R20 (3 a) Q9 C32 C38 C30 C35 29 \ 22 C36 C39 33 34 IC1 R49 C40 R7 • C59) IC2 R54 C51 JP47 R37 R38 R25 R36 SP-SP+ BLK GRN WHT AED

R2/C R1 D1

BE C Q3 / C

BE D2 Q1

SCHEMATIC DIAGRAM



BLOCK DIAGRAM

IC1 D1 Q1,Q2 C1 R1 Tone Diode DC-DC Ringer C2 R2 Bridge Circuit R H/S Q6 D4 Q3,Q4 Transmit MIC Handset Dial Pulse Amp Amp Diode Switch Receiving S1 and Transmitting Bridge SPEAKER On/Off and Control Address Signal **⇒ C45** MIC DIALER SP-PHONE Key Board DTMF Amp **SPEAKER** Switch Output and Control Circuit LCD IC103 IC2 LCD **EEPROM** DRIVER

CIRCUIT OPERATIONS

Note:

The circuit diagram may be modified at any time with the development of new technology.

■ TELEPHONE LINE INTERFACE and PULSE DIAL CIRCUIT

When the hook switch S1 is ON (off-hook), the circuit is closed, and current is supplied to the base of Q3 via the diode bridge D4 and Q3 is On \rightarrow Q4 is ON (OFF-HOOK condition).

Q4 and Q3 are the dial pulse generating circuits, and are driven by the DIALER (IC1), when the DIALER Pin 2 of IC1 is $LOW \rightarrow Q3$ is OFF and Q4 is OFF. (break)

If port Pin 2 is HIGH → Q3 is ON → Q4 is ON. (make)

TONE DIAL CIRCUIT

Function:

The tone dialing circuit consists of a DTMF (Dual Tone Multi Frequency) signal generator (outputted from Pin 12 of the IC1) for tone dialing, and also a circuit for outputting the signal to line.

The DTMF circuit identifies inputs from the 12 keys (1,2,3,4,5,6,7,8,9,0, * and #) by means of a total of seven frequencies, that is four low frequencies (Low group) and three high frequencies (High group).

Circuit Description:

When a dial key is presses, a DTMF signal is outputted from Pin 12 of IC1 as an analog synthetic wave.

The signal flow to the line is as follows.

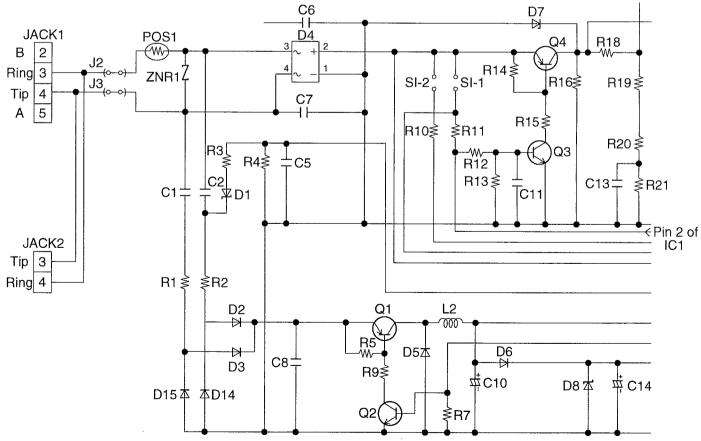
Pin 12 of IC1 \rightarrow Q6 \rightarrow R18 \rightarrow Q4 \rightarrow Tel Line.

The DTMF signal is sent to the line via the following path. Q6 is an amplifier which is used to output the signal to line. Shown below is the signal flow used to output the DTMF signal from the handset as a monitor tone when a dial key is pressed.

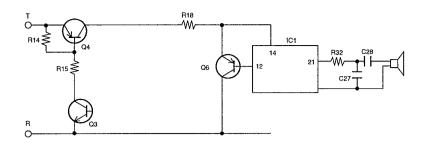
Pin 21 of IC1 → R32 → C28 → Handset Speaker.

The signal combination and frequency corresponding the each dial key is shown below.

Circuit Diagram



Circuit Diagram



Tone Frequencies

High Group Low Group	H1	H2	H3
L1	1	2	3
L2	4	5	6
L3	7	6	9
L4	*	0	#

Low Group	Frequencies	High Group	Frequencies
L1	697 Hz ± 1.5%	H1	1209 Hz 士 1.5%
L2	770 Hz ± 1.5%	H2	1336 Hz ± 1.5%
L3	852 Hz ± 1.5%	H3	1477 Hz ± 1.5%
L4	941 Hz ± 1.5%		

RINGER CIRCUIT

Circuit Operation:

The bell signal passes through C1 (R1) \rightarrow supplying power to pin 26 and 22 of IC1. (Q1, Q2 is DC-DC converter.) signal input to pin 31 of IC1.

The ring signal is outputted from Pin 27 of IC1, and its volume is adjusted in adjusted in 3 steps (H-M-L) by programming then impressed on the speaker, and so is generated.

D1..... Bell sensitivity adjustment

Circuit Diagram R C R3 31 FCI 26 C2 R4 **≶** C5 D1 22 R1 ≹ R2 ≸ R59^{Q8} VDD CM **本 D16** 25 L2 D2 D6 **本 D5** D3 D11 ≹R9 C8 **本D14** C10 本 D8 本 本 C14 D15 本 R7 Q2 D9

SPEAKERPHONE CIRCUIT

Function:

This circuit controls the automatic switching of the transmitted and received signals, to and from the telephone line, when the unit is used in the hands-free mode.

Circuit Operation:

The Speakerphone can only provide a one-way communication path.

In other words, it can either transmit an outgoing signal or receive an incoming signal at a given time, but cannot do both simultaneously. Therefore, a switching circuit is necessary to control the flow of the outgoing and incoming signals. This switching circuit is contained in IC1 and consists of a Voice Detector, Tx Attenuator, Rx Attenuator, Comparator and Attenuator Control. The circuit analyzes whether the Tx (transmit) or the Rx (receive) signal is louder, and then it processes the signals such that the louder signal is given precedence.

The Voice Detector provides a DC input to the Attenuator Control corresponding to the Tx signal.

The Comparator receives a Tx and a Rx signal, and supplies a DC input to the Attenuator Control corresponding to the Rx signal. The Attenuator Control provides a control signal to the Tx and the Rx Attenuator to switch the appropriate signals on and off. The Attenuator Control also detects the level of the volume control to automatically adjust for changing ambient conditions.

1) Transmission Signal Path

The input signal from the microphone is sent through the circuit via the following path:

• Mic → Pin 7 and 9 IC1 → Pin 12 of IC1 → Interface (Q6) → R18 → Telephone Line.

2) Reception Signal Path

Signals received from the telephone line are outputted at the speaker via the following path:

• Telephone Line → C22 → Pin 15 of IC1 → Pin 21 of IC1 → Pin 19 of IC1 → Pin 27 of IC1 → Speaker.

3) Control Signal Path

Control signals for transmission and reception are inputted to IC1 via the following path:

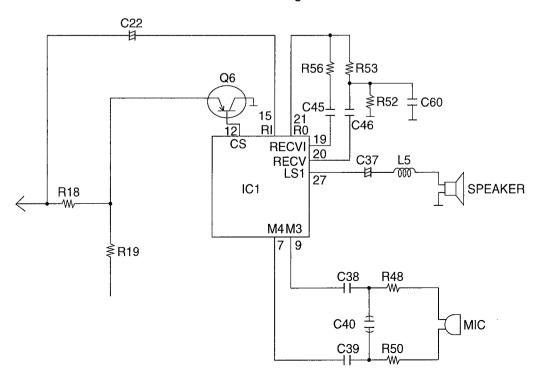
Transmission Control Signal Path

• Fixed (inside IC1)

(Reception Control Signal Path)

• Telephone Line → C22 → Pin 15 of IC1 → Pin 21 of IC1 → Pin 20 of IC1.

Circuit Diagram



HANDSET CIRCUIT AND HEADSET CIRCUIT

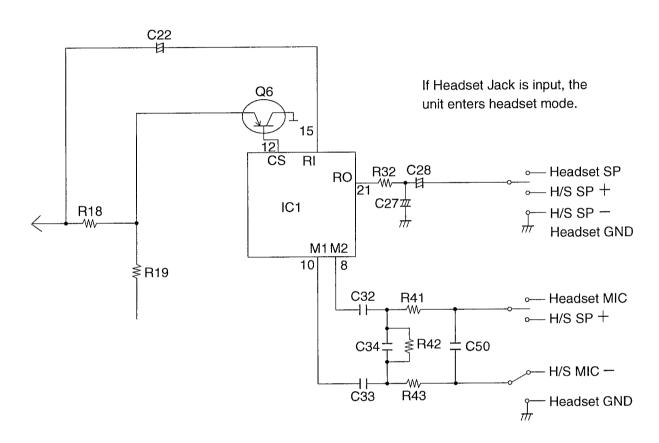
1) Transmission Signal Path

The input signal from the microphone passes through: MIC Pin 8 and 10 IC1 \rightarrow Pin 12 of IC1 \rightarrow Interface (Q6) \rightarrow R18 \rightarrow Telephone Line.

2) Reception Signal Path

Signals received from the telephone line passed through: Telephone Line \rightarrow C22 \rightarrow Pin 15 of IC1 \rightarrow Pin 21 of IC1 \rightarrow Speaker.

Circuit Diagram

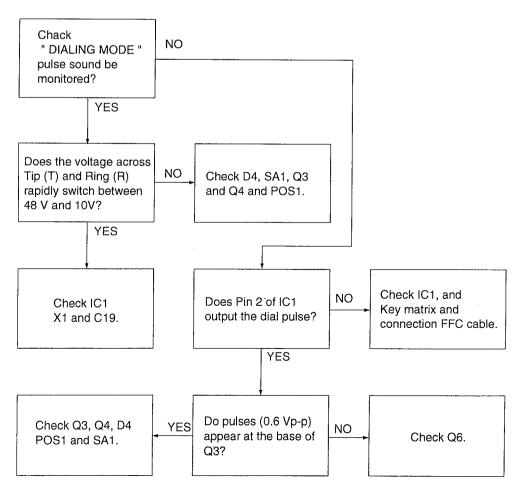


TROUBLE SHOOTING GUIDE

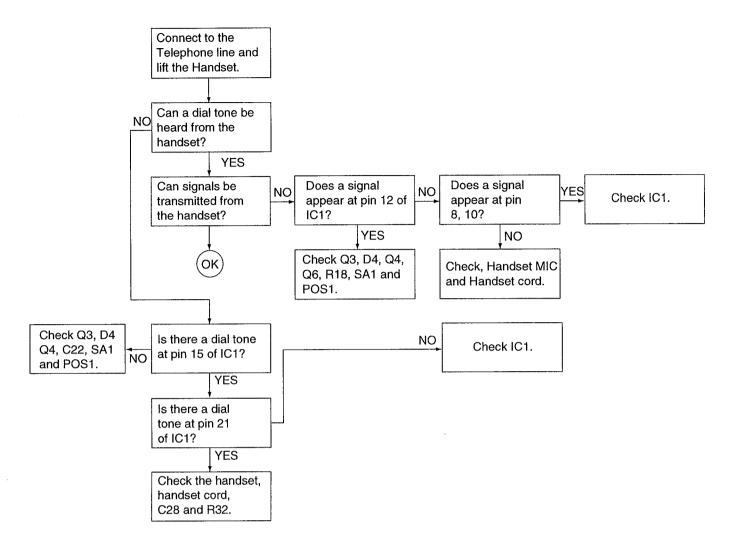
1. SERVICE HINTS

SYMPTOM	CURE
Pulse will not dial.	Check Q3 and Q4. Check "DIALING MODE"
No pulse, can hear dialing but no number output.	Check IC1. Check "DIALING MODE"
Rings, no dial tone, can't dial out, no audio circuit, dead.	Check IC1.
No dial tone on Handset.	Check Q3, Q4 and IC1.
Memory does not work.	Check IC2.
Unit rings, has dial tone, memory does not work.	Check IC2.
Rings but can't answer.	Check S1.
Doesn't dial.	Check IC1.
Dead.	Check IC1.
Rings, no dial tone, no pulse or tone dial.	Check Q3 and Q4, D4.
No rings.	Check C1, C2, R1, R2, R4 D1, Q1, Q2 and IC1.
No volume Handset.	Check IC1 and IC2.
Buttons stick under upper cabinet assembly. From key board.	Adijust the setting of buttons.
No pulse dial.	Check Q3, Q4 and Q6. Check "DIALING MODE

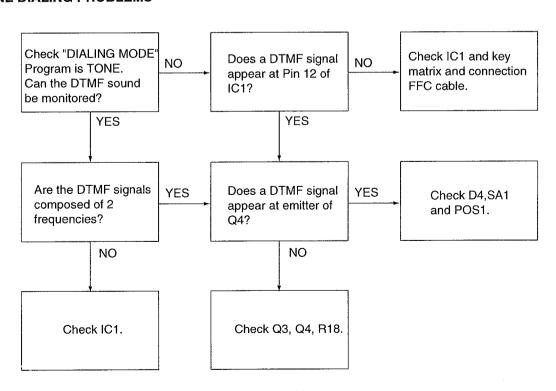
2. PULSE DIALING PROBLEMS



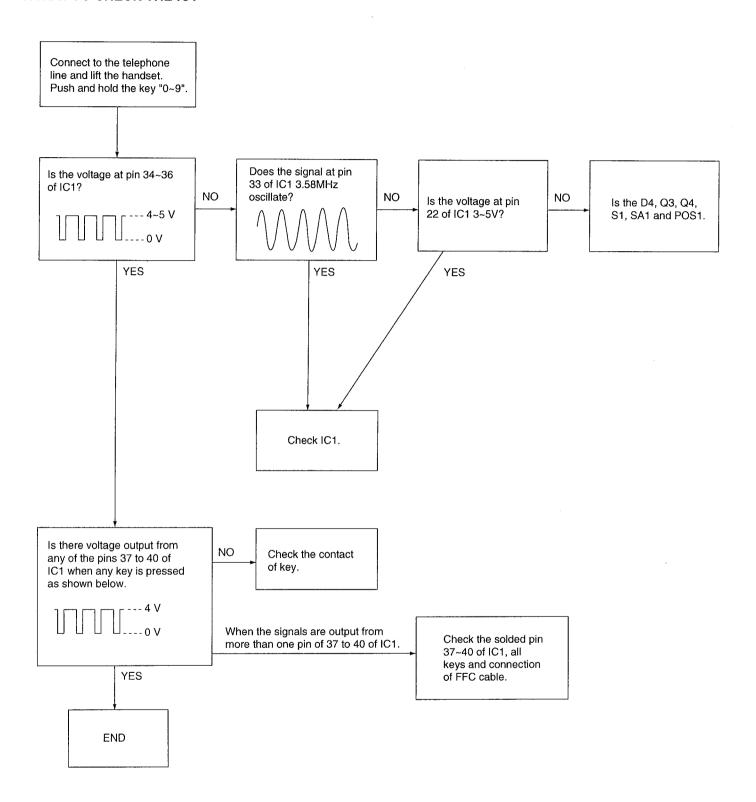
3. PROBLEMS WITH THE HANDSET



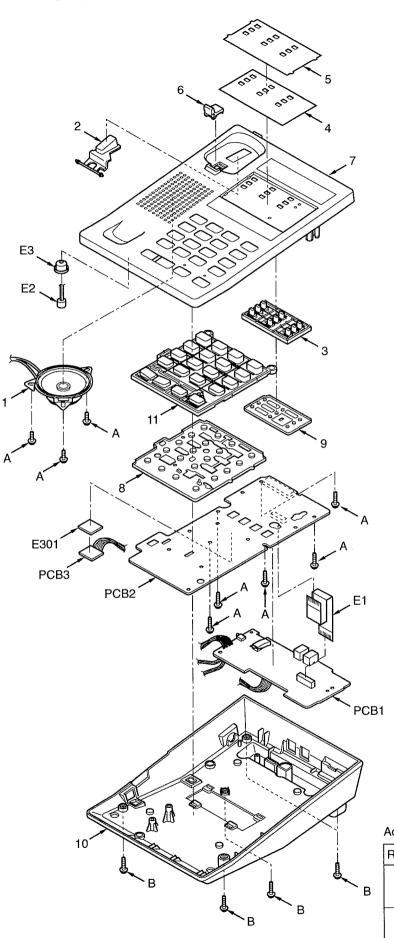
4. TONE DIALING PROBLEMS



5. HOW TO CHECK THE IC1



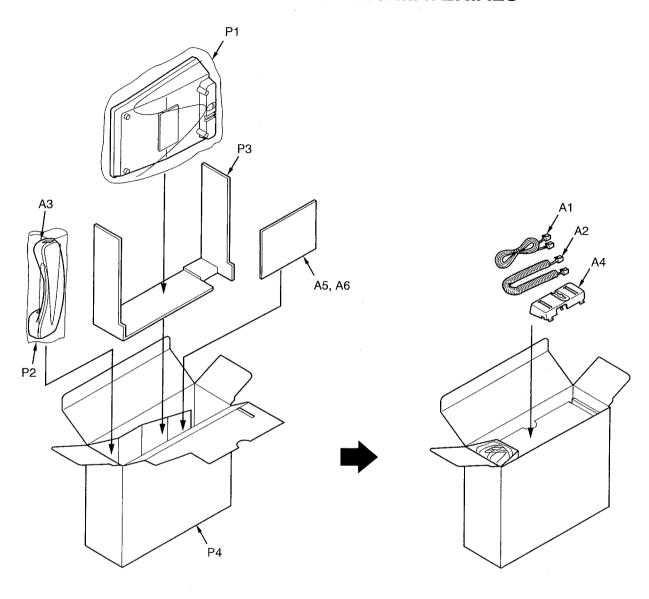
CABINET AND ELECTRICAL PARTS LOCATION



Actual Size of Screws

Ref. No	Part No.	Screw
Α	XTW3+S10P	
В	XTW3+S14P	

ACCESSORES AND PACKING MATERIALS



This replacement parts list is U. S. A. version only. Refer to the simplified manual (cover) for Canada or other areas.

REPLACEMENT PARTS LIST Model KX-TS15-W Notes: 1. RTL (Retention Time Limited) The marking (RTL) indicates that the Retention Time is limited for this item. After the discontinuation of this assembly in production, the item will continue to be available for a specific period of time. The retention period of availability is dependent on the type of assembly, and in accordance with the laws governing part and product retention. After the end of this period, the assembly will no longer be available. Important safety notice. Components identified by the $\ \ \, \underline{\ \ }$ mark special characteristics important for safety. When replacing any of these components, use only manufacturer's specified parts. The S mark indicates service standard parts and may differ from production parts. **RESISTORS & CAPACITORS** Unless otherwise specified. All resistors are in ohms (Ω) K=1000 $\!\Omega,$ M=1000K $\!\Omega$ All capacitors are in MICRO FARADS (μF) P= $\mu \mu F$ *Type &Wattage of Resistor ERC:Solid ERX:Metal Film PQ4R:Carbon ERD:Carbon ERG:Metal Oxide ERS:Fusible Resistor PQRD:Carbon ER0:Metal Film ERF:Cement Resistor Wattage 12:1/2W 1:1W 2:2W 3:3W 14,25:1/4W 10,16:1/8W Type & Voltage of Capacitor Type ECFD:Semi-Conductor ECCD, ECKD, ECBT, PQCBC: Ceramic ECQE,ECQV,ECQG: Polyester ECQS:Styrol PQCUV:Chip ECEA, ECSZ: Electrolytic ECQP: Polypropylene ECQMS:Mica Voltage Others ECQ Type ECQG ECSZ Type ECQV Type 1H: 50V 05: 50V 0F:3.15V 0J :6.3V 1V :35V :10V 50,1H:50V 1A:10V 2A:100V 1:100V 1A 2E:250V 2:200V 1V:35V 1C :16V 1J :63V :100V 0J:6.3V 1E,25:25V 2A 2H:500V

Ref. No.	Part No.	Part Name & Description	Pcs/Set
	(CABINET AND ELECTRICAL PARTS	
	T	Too	
1	PQAS65P37Z	SPEAKER	1 1
2	PQBH10027Z1	BUTTON, HOOK	1
3	PQBX10322Z1	BUTTON, 9 KEY	1
4	PQGD10156Z	TEL CARD	1
5	PQGV10034Z	TEL CARD COVER	1
6	PQKE10070Z3	HANGER	1
7	PQKM10357Z1	UPPER CABINET	1
8	PQSX10088Z	RUBBER SWITCH, 20 KEY	1
9	PQSX10089Z	RUBBER SWITCH, 9 KEY	1
10	PQYF10138Z1	LOWER CABINET	1
1 11	PQYT10012Z1	BUTTON, 19 KEY ASS'Y	1
		, in the second	
			1
1			
-			
1			

Ref. No.	Part No.	Part Name & Description	Pcs/Set
		ACCESSORIES	<u> </u>
A1	PQJA10075Z	TELEPHONE CORD	1
A2	PQJA212M	CURL CORD	1
A3	PQJXF0102Z	HANDSET	1
A4	PQKL24Y81	STAND S	1
A 5	PQQW12040Z	QUICK REFERENCE GUIDE	1
A6	PQQX12105Z	(for Spanish) INSTRUCTION BOOK	1
, (0	GG/CIZ TOOL		
		PACKING MATERIALS	
P1	PQPH89Y	PROTECTION COVER	1
		(for Unit)	
P2	XZB10X35A02	PROTECTION COVER	1
		(for Handset)	١.
P3	PQPD10415Z	CUSHION	1
P4	PQPK12682Z	GIFT BOX	1
	MAIN	PRINTED CIRCUIT BOARD PARTS	
PCB1	PQWP1TS15W	MAIN, P. C. BOARD ASS'Y (NLA)	1
		(100)	
104	DOMA COFOE	(ICS)	1
IC1 IC2	PQVIAS2525 PQVI93LC66AT	IC	
102	I QVISSEOUAT		`
		(TRANSISTORS)	
Q 1	2SB1209	TRANSISTOR(SI)	1
Q 2	PQVT2N6517CA	TRANSISTOR(SI)	1
Q 3	PQVT2N6517CA	TRANSISTOR(SI)	1
Q 4	2SA1625	TRANSISTOR(SI) (or 2SA1776P)	1
Q 5	PQVTKSB564AC	TRANSISTOR(SI)	1
Q 6	PQVTKSB564AC	TRANSISTOR(SI)	1
Q 7	2SD1819A	TRANSISTOR(SI)	1
Q 8	PQVT2N6517CA	TRANSISTOR(SI)	1
Q10	2SD1819A	TRANSISTOR(SI)	1
Q11	2SD1819A	TRANSISTOR(SI)	1
		(DIODES)	
D 1	MA4200	DIODE(SI)	1
D 2	PQVDS5688G	DIODE(SI)	1
D 3	PQVDS5688G	DIODE(SI)	1
D 4	PQVDS1YB40F1	DIODE(SI) S	1
D 5	1SS244	DIODE(SI)	1
D 6	1SS119	DIODE(SI) (or 1SS133 or MA165)	1
D 7	MA4082	DIODE(SI)	1
D 8	MA4043	DIODE(SI)	1
D 9	MA4051	DIODE(SI)	1
D11	PQ4R10XJ000	0 (RESISTOR)	1
D12	MA700A	DIODE(SI)	1
D14	PQVDS5688G	DIODE(SI)	1
D15	PQVDS5688G	DIODE(SI)	1
D16	1SS119	DIODE(SI) (or 1SS133 or MA165)	1 1

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F	Ref. No.	Part No.	Part Name, Description & Value		Pcs/Set	Ref. No.	Part No.	Value		Pcs/Set
D.	17	MA143	DIODE(SI)		1	R39	ERDS2TJ222	2.2K		1
						R40	PQ4R10XJ182	1.8K	s	1
			(COILS)		l	R41	PQ4R10XJ222	2.2K	S	1 1
L2		PQLE109	COIL		1	R42	PQ4R10XJ272	2.7K	S	1
L5		PQLQXE122J	COIL		1	R43	PQ4R10XJ222	2.2K	S	1
					'	R44	PQ4R10XJ182	1.8K	S	
		1				R47	PQ4R10XJ102	1K	S	1 1
-		Ì	(JACKS)		l	R48	PQ4R10XJ222	2.2K	S	1 1
CI	V 3	PQJJ1TB2S	JACK SOCKET, HANDSET		1		I GHITTONOZZZ	2.21	3	' '
JΑ	CK1	PQJJ1T008Z	JACK, TEL		2	R50	PQ4R10XJ222	2.2K	S	1 1
	CK2	PQJJ1C001Z	JACK, SOCKET		1	R51	PQ4R10XJ102	1K	S	'
			,			R52	PQ4R10XJ103	10K	S	1
1						R53	PQ4R10XJ103	10K	S	1 1
						R54	PQ4R10XJ105	1M	S	1 1
			(OTHERS)			R55	PQ4R10XJ105	1M	S	1
CN	J1	PQJS18X54Z	CONNECTOR		1 1	R56	PQ4R10XJ000	0	J	
E1		PQJE10090Z	LEAD WIRE		1	R57	PQ4R10XJ000	0		
E2		PQJM122Z	MICROPHONE		1	R59	PQ4R10XJ224	220K	S	
E3		PQMG10022Z	MIC SPACER		1				Ü	'
PC)S1	PQRPAR390N	THERMISTOR	s	1	R60	PQ4R10XJ102	1K	s	1
S1		ESE14A211	SWITCH, HOOK		1	R62	PQ4R10XJ473	47K	S	
X1		PQVBKBR3.58M	CRYSTAL OSCILLATOR		1	R63	PQ4R10XJ564	560K	S	1 1
ZN	R1	PQVDDSS301L	VARISTOR		1	R64	PQ4R10XJ473	47K	S	1 1
						R65	PQ4R10XJ563	56K	S	1
						R80	ERJ3GEYJ825	8.2M		1
						JP37	PQ4R10XJ000	О		1
						JP40	PQ4R10XJ000	О		1
						JP41	PQ4R10XJ000	0		1
						JP46	PQ4R10XJ000	0		1
						JP47	PQ4R10XJ000	0		1
			(RESISTORS)							
R 1	l	ERDS2TJ561	560		1					
R 2		ERDS2TJ561	560	- 1	1					
R 3		ERDS2TJ334	330K		1					
R 4	ļ .	PQ4R10XJ563	56K	s	1					
R 5	;	PQ4R10XJ272	2.7K	s	1	1.				
R 7	.	PQ4R10XJ331	330	s	1					
R 9) [PQ4R10XJ562	5.6K	S	1			(CAPACITORS)		ĺ
İ	ı			i	ĺ		ECQE2155T370	1.5		1
R10		PQ4R10XJ334	330K	S	1		ECQE2155T370	1.5		1
R1		PQ4R10XJ104	100K	S	1	1	PQCUV1H102J	0.001	S	1
R12	1	PQ4R10XJ823	82K	S	1	C 6	ECKD2H681KB	680P	S	1
R13		PQ4R10XJ334	330K	S	1	C 7	ECKD2H681KB	680P	S	1
R14		PQ4R10XJ473	47K	S	1	C 8	ECQE2223KF	0.022		1
R1		PQ4R10XJ392	3.9K	S	1					
R16		PQ4R10XJ152	1.5K	S	1	l I	ECEA0JK221	220	S	1
R18	· ·	ERDS1TJ270	27	S	1	C11	PQCUV1E333MD	0.033	S	1
R19	,	PQ4R10XJ271	270	S	1	C12 C13	ECEA1CKS100 PQCUV1H103KB	10 0.01	S	1 1
R20		PQ4R10XJ222	2.2K	s	1	C14	ECEA0JU471	470		1
R2		PQ4R10XJ392	3.9K	s	1	C15	ECEA1HKS010	1	s	1
R26		PQ4R10XJ000	О		1		PQCUV1H102J	0.001	s	1
1					į	1 1	ECEA1CK101	100	s	1
R2	7	PQ4R10XJ104	100K	s	1		PQCUV1H120JC	12P	ļ	1
R28	i	PQ4R10XJ473	47K	s	1					į
R29	- 4	PQ4R10XJ104	100K	s	1	C22	ECEA1CKS100	10	s	1
1	İ			I	ł	C24	ECEA0JKS220	22	s	1
R30		PQ4R10XJ104	100K	s	1	C25	PQCUV1H102J	0.001	s	1
R32	2	PQ4R10XJ270	27	s	1	C26	PQCUV1H103KB	0.01		1

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Ref. No.	Part No.	Part Name, Description & Value	Pcs/S	et	Ref. No.	Part No.	Value	Pcs/Set
C27 C28	ECEA1HKS3R3 ECEA1HKS2R2	3.3 2.2	1		CN102	PQJS18X54Z	(OTHERS) CONNECTOR	1
C29 C30	ECEA1CK101 PQCUV1H102J	0.001	s 1					
C31 C32	PQCUV1H102J PQCUV1E104MD	0.001 0.1	1					
C33 C34	PQCUV1E104MD PQCUV1E683KB	0.068	1 1		B.400	DO 4D 40 V 100 4	(RESISTORS)	
C35 C36	PQCUV1H102J PQCUV1H102J	0.001	5 1 5 1		R108	PQ4R10XJ334	330K S	1
C37 C38	ECEA1CK101 PQCUV1E104MD		6 1 6 1		R122 R123	PQ4R18XJ102 PQ4R18XJ102	1K S	1 1
C39	PQCUV1E104MD	0.1	5 1		R124	PQ4R18XJ473	47K S	1
C42 C43	ECEA1HKS010 ECEA1HKS010		5 1 5 1		J103	PQ4R18XJ000	o s	1
C44	ECEA1CKS100	10	3 1					
C45 C46	PQCUV1H103KB PQCUV1H223KB	0.01 0.022	1					
C48	PQCUV1H102J	0.001	1					
C49	PQCUV1H102J	0.001	5 1					
C50 C51	PQCUV1H102J PQCUV1H103KB	0.001	5 1 1					
C52	PQCUV1H103KB	0.01	1			SUB P.0	C.BOARD PARTS	
C53	PQCUV1H560JC	56P	1 1	- [PCB3	PQWP3TS15W	SUB, P. C. BOARD ASS'Y (NLA)	1 1
C54 C55	PQCUV1H560JC PQCUV1H560JC	56P 56P	1		F C 55	1 GW 31313W	300, 1 : 0. 20, 112 / 100 · (112.1)	
C56	PQCUV1H560JC	56P	1	-				
C58	ECA0JM222	0.0022	1 1		Q 1	UN5113	(TRANSISTORS) TRANSISTOR(SI) S	1 1
C59	PQCUV1C105ZF	1	'		Q 2	UN5213	TRANSISTOR(SI) S	1
C60	PQCUV1H223KB	0.022	1		Q 3	2SB1218A	TRANSISTOR(SI)	1
C61	PQCUV1H102J	0.001	5 1					
					D 1	MA110	(DIODES) DIODE(SI)	1
					D 2	MA8030	DIODE(SI)	1
					E301	PQHE10108Z	(OTHERS) SPONGE	1
	OPERA	TION P.C.BOARD PARTS	<u> </u>	\dashv			(RESISTORS)	
		Tenent of a Board Acces	1 1		R 1 R 2	ERJ3GEYJ224	220K 56K	1 1
PCB2	PQWP2TS15W	OPERATION, P. C. BOARD ASS'Y (NL)	A) 1		H 2	ERJ3GEYJ563	SOK	'
		(TRANSISTORS)						
Q101	2SD1819A	TRANSISTOR(SI)	1					<u> </u>
D100		(DIODES)	1					
D109	MA110	DIODE(SI)						
D110 D111	MA110 MA110	DIODE(SI) DIODE(SI)	1 1					
LED101 LED102	PQVDSML210LT PQVDSML210LT	LED LED	1					
								•
	<u> </u>							